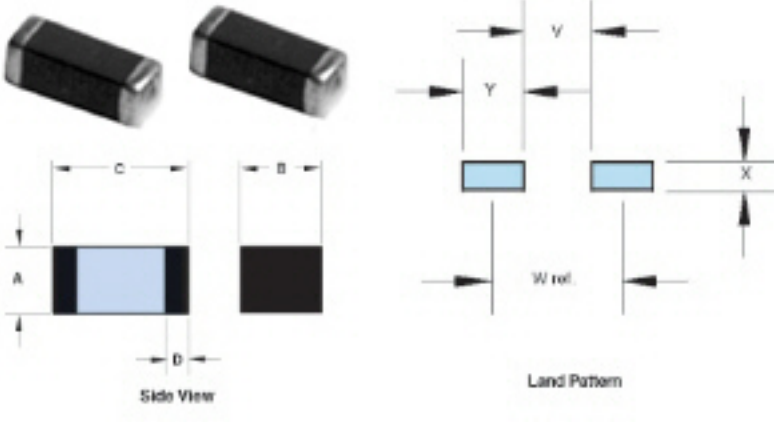
Fair-Rite Products Corp. PO Box J,One Commercial Row, Wallkill, NY 12589-0288
Phone: (888) 324-7748 www.fair-rite.com

Fair-Rite Product's Catalog
Part Data Sheet, 2508053007Y3
Printed: 2010-11-09



Part Number:	2508053007Y3
Frequency Range:	Medium Current
Description:	MULTI-LAYER CHIP BEAD
Application:	Suppression Components
Where Used:	Board Component
Part Type:	Chip Beads
Preferred Part:	✓

Mechanical Specifications

Weight:	.010	(g)

Part Type Information

Fair-Rite offers a broad selection of cost effective multi-layer chip beads to suppress conducted EMI signals. Chip beads can be used in an array of devices such as cellular phones, computers, laptops, pagers, etc. The small package sizes accommodate automated placements and allow for a dense packaging of circuit boards. Chip beads are 100% tested for impedance and dc resistance. They are available in standard, high and GHz signal speeds. The multi-layer chip beads are organized by increasing package size and current carrying capacity.

-All multi-layer chip beads are supplied taped and reeled, if required bulk packed chip beads can be provided.

-The impedance values listed are typical values. The nominal impedance with a ± 25% tolerance is specified for the + marked 100 MHz. Chip beads are measured for impedance on the HP 4291A and fixture HP 16192A.

-Chip beads have plated contacts, 100% tin over a nickel undercoating. They can accommodate both reflow and wave soldering technologies.

-The suggested land patterns are in accordance to the latest revision of IPC-7351.

-Recommended storage and operating temperature range is -55°C to 125°C.

-Our 'Chip Bead Kit' (part number 0199000018) is available for prototype evaluation.

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Mechanical Specifications

Dim	mm	mm tol	nominal inch	inch misc.
A	0.90	±0.20	0.035	-
B	1.25	±0.20	0.049	-
C	2.00	±0.20	0.079	-
D	0.50	±0.30	0.020	-
E	-	-	-	-
F	-	-	-	-
G	-	-	-	-
H	-	-	-	-
J	-	-	-	-
K	-	-	-	-

Electrical Specifications

Typical Impedance (Ω)	
50 MHz	23
100 MHz+	30 ±25%
500 MHz	41
1000 MHz	41

Electrical Properties	
Signal Speed	Standard
Max DCR (Ω)	0.03
Max Current (mA)	3000

Land Patterns

V	W ref	X	Y	Z
0.600 0.024	1.900 0.075	1.500 0.059	1.300 0.051	- -

Winding Information

Turns Tested	Wire Size	1st Wire Length	2nd Wire Length
-	-	-	-

Reel Information

Tape Width mm	Pitch mm	Parts 7 " Reel	Parts 13 " Reel	Parts 14 " Reel
8	4	4000	10000	-

Package Size

Pkg Size
0805 (2012)

Connector Plate

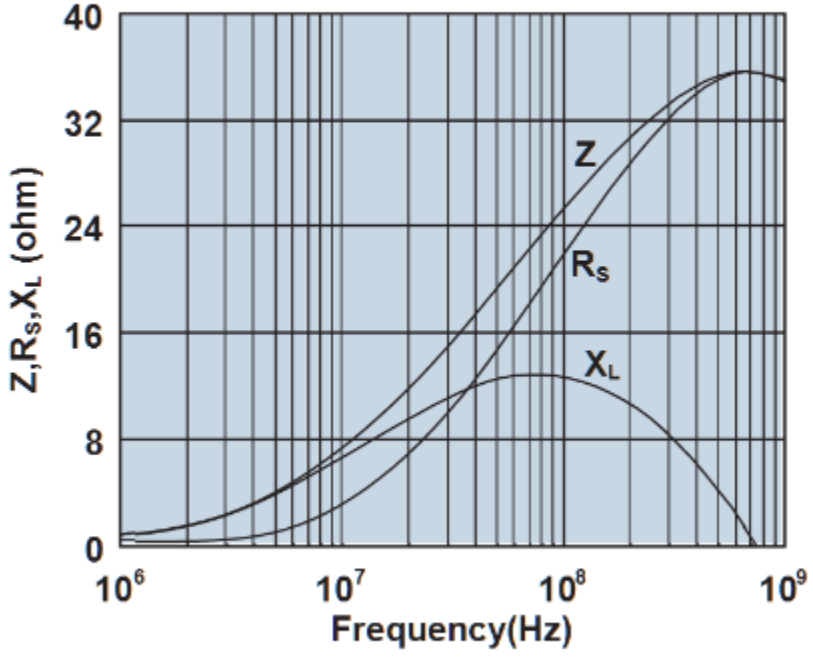
# Holes	# Rows
-	-

Legend

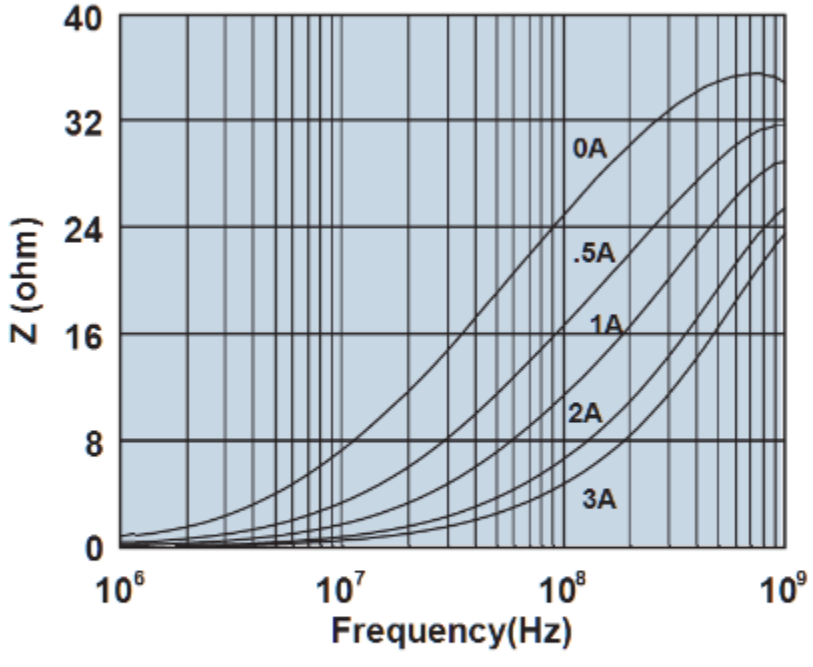
+ Test frequency
Preferred parts, the suggested choice for new designs,have shorter lead times and are more readily available.
The column H(Oe) gives for each bead the calculated dc bias field in oersted for 1 turn and 1 ampere direct current. The actual dc H field in the application is this value of H times the actual NI (ampere-turn) product. For the effect of the dc bias on the impedance of the bead material, see figures 18-23 in the application note How to choose Ferrite Components for EMI Suppression.
A ½ turn is defined as a single pass through a hole.

Σl/A - Core Constant
l_e: Effective Path Length
A_e: Effective Cross-Sectional Area
V_e: Effective Core Volume
A_L - Inductance Factor $\left(\frac{L}{N^2}\right)$
NI - Value of dc Ampere-turns
N/AWG - Number of Turns/Wire Size for Test Coil

2508053007Y3



Impedance, reactance, and resistance vs. frequency.



Impedance vs. frequency with dc bias.